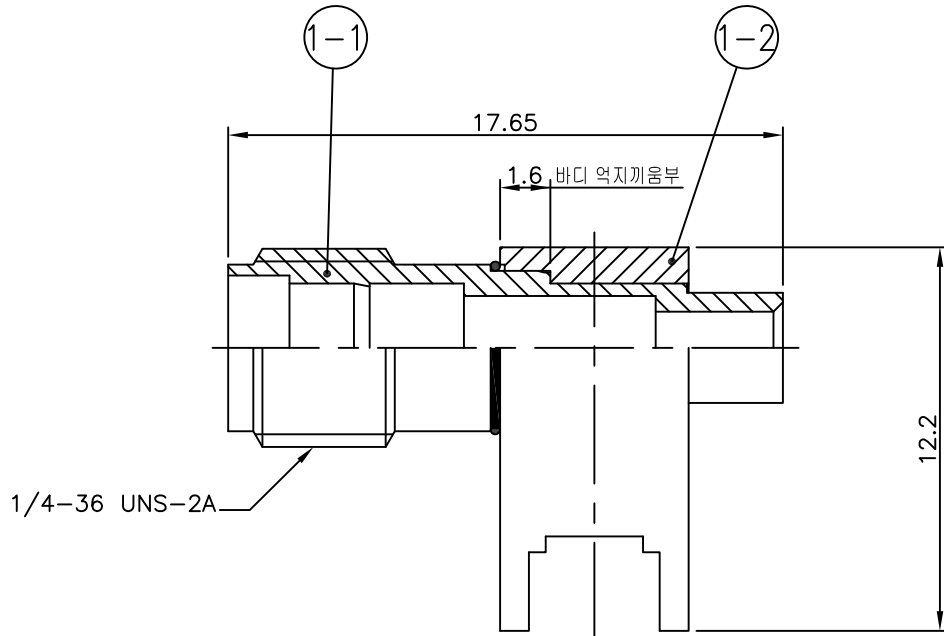


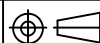
REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.H.KIM		2024.05.14.



주 기

- BODY A+B 억지끼움 후 은땜 작업 할 것.
 - 원형 BODY에 은납 RING 조립 후 사각 BODY 억지끼움 할 것.
 - 은납RING 주위에 플렉스 도포 후 은땜 작업 할 것.
- 은납RING SIZE : 내경 Ø4.7, 0.3t (CSO00073-N/1)

1-2	BODY (B)	1	MBsBD C3604BD-F	Gold Plate	DBB00527-5/1	DBD04943-1/1
1-1	BODY (A)	1	MBsBD C3604BD-F			DBD04942-1/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE	

TOLERANCE	Decimal ±0.2	DATE 2024. 05. 14.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	Angle ±1°	APPROVED BY				
MATERIAL _____		CHECKED BY			TITLE BODY A+B 결함품	
		DRAWN BY	S.H.KIM			
FINISH _____		SCALE 4/1	UNIT mm		A4	
						DWG NO. DBB00527-5/1
					REVISION I R	SHEET 1 of 1